Electronic Patent Application Fee Transmittal

Application Number:	10681835
Filing Date:	07-Oct-2003
Title of Invention:	NON-COVALENT ASSEMBLY OF MULTILAYER THIN FILM SUPRAMOLECULAR STRUCTURES
First Named Inventor/Applicant Name:	William Grant McGimpsey
Filer:	Marlo M. Schepper
Attorney Docket Number:	WPI03-02

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Utility under 35 USC 111(a) Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD($)
Basic Filing:				
Maintenance Fee Due at 3.5 years	2551	1	490	490
Surcharge after Expiration-Unintentional	1558	1	1640	1640
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD($)
Extension-of-Time:				
Miscellaneous:				
			Total in USD ($)	**2130**